

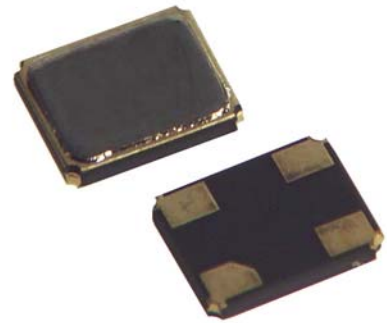
P/N: WTL2M10810

SEAM SEALED CERAMIC 2.0 X 2.5mm SMD



FEATURE

- Ultra thin, thickness 1.0mm
- Leadless type
- High precision characteristic covering up to high frequency range
- Designed for automatic mounting and reflow soldering
- Emboss taping specification
- The best choice of Bluetooth wireless communication sets. DSN, PDA and mobile phone



ELECTRICAL SPECIFICATIONS

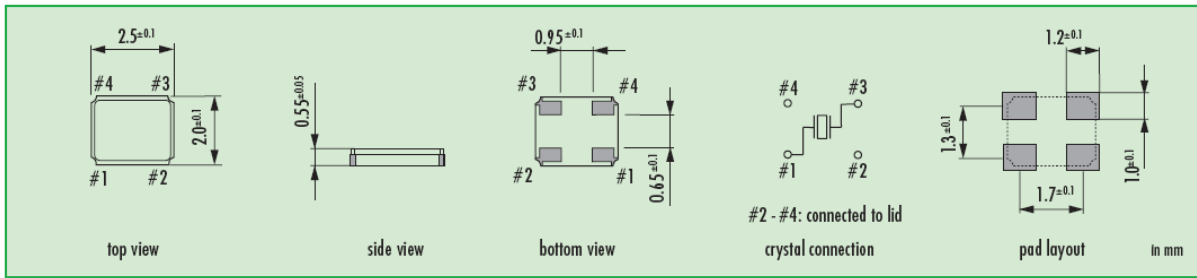
Output Frequency Range	26.000 MHz
Mode	Fundamental
Frequency Tolerance (at 25°C)	±10ppm
Frequency Stability Over Operating Temperature Characteristics	±10ppm
Operating Temperature Range	-20 °C to +70 °C
Storage Temperature Range	-55 °C to + 125 °C
Shunt Capacitance (C ₀)	5.0 pF Max
Driver Level (Typical)	100µW
Load Capacitance(C _L)	9pF
Aging @25°C 1 st year (Max)	±3ppm/ first year
ESR	80Ω Max

REMARK: SPECIFICATIONS SUBJECT TO CHANGE WITHOUT PRIOR NOTICE. PLEASE CONFIRM WITH OUR SALES ENGINEER.

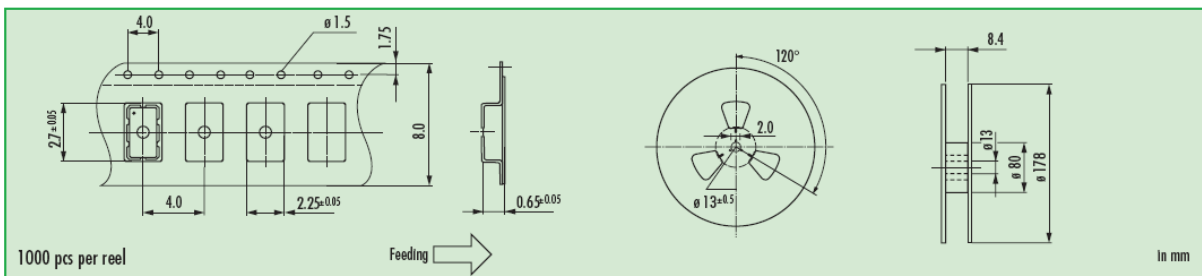
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DIMENSION



TAPE SPECIFICATION



REFLOW CONDITION

